

N5TL-U-A High Power LED

Introduction

The N5TL-U-A LED from SemiLEDs brings industry leading technology to the solid state lighting market with its high quality and performance. With a silicone lens, N5TL-U-A LEDs from SemiLEDs feature very high brightness and efficacy, as well as excellent lifetime.



N5TL-U-A LEDs also feature a special design to fit secondary optics for various lighting applications. The user can easily get uniform light with any secondary optics.

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RoHS Compliant

Characteristics

Absolute Ratings

Parameter	Rating		
Parameter	UV Series		
DC Forward Current (mA)	500 mA		
LED Junction Temperature	150°℃		
LED Operating Temperature	-40°C ~125°C		
Storage Temperature	-40°C ~125°C		
Soldering Temperature	Max. 260°C / Max. 10sec. (JEDEC 020c)		
ESD Sensitivity	2,000 V HBM (JESD-22A-114-B)		
Preconditioning	Acc. to JEDEC Level 2		

Notes:

- 1. Never operate the LEDs in reverse bias.
- 2. Do not drive at rated current for more than 5 seconds without proper thermal management.
- 3. When the LEDs are illuminating, operating current should be decided after considering the packages maximum temperature.
- 4. Caution: These devices emit high intensity UV/NUV light. Necessary precautions must be taken during operation. Do not look directly into the light or look through the optical system when in operation. Protective eyewear should be worn at all times during operation.
- 5. Lens discoloration may occur with prolonged exposure to UV/NUV light. Lens material will need to be tested for UV/NUV light compatibility and durability.

General Characteristics at 350mA

Part number	Color	Peak Wavelength, Wp		2θ _{1/2}	Temperature Coefficient of Vf (mV/°C)	Resistance
		Min	Max		$\Delta V_F / \Delta T_J$	(°C/W) RΘ _{J-S}
	U50	390	400	140	-	1.5
N5TL-U-A	U60	400	410	140	-	1.5
	U70	410	420	140	-	1.5

Notes:

1. The peak/dominant wavelength is measured with an accuracy of ±1nm.





Luminous Flux and Forward Voltage

		Performance at Test Current 350mA				Performance at 500mA
Part number	Color	Group	Minimum	VF		*Calculated Minimum
			Radiation Power (mW)	Min	Max	Radiation Power (mW)
		G1	850	11	15	1275
	U50	G2	900	11	15	1350
	(390~400nm)	G3	950	11	15	1425
		H1	1000	11	15	1500
		G1	850	11	15	1275
	U60	G2	900	11	15	1350
N5TL-U-A	(400~410nm)	G3	950	11	15	1425
		H1	1000	11	15	1500
		G1	850	11	15	1275
	U70	G2	900	11	15	1350
	(410~420nm)	G3	950	11	15	1425
		H1	1000	11	15	1500

Note:

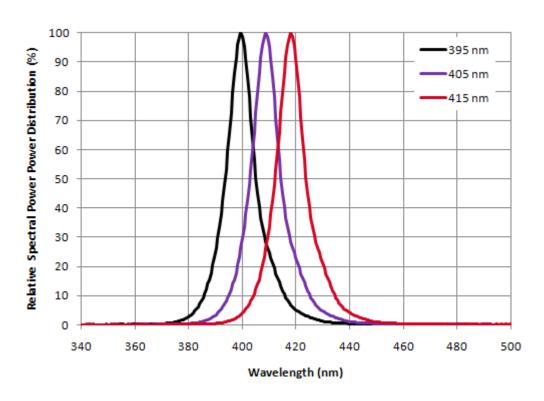
- 1. Luminous flux is measured with an accuracy of $\pm 10\%$
- 2. The forward voltage is measured with an accuracy of $\pm 0.2V$
- * Calculated flux values are for reference only.





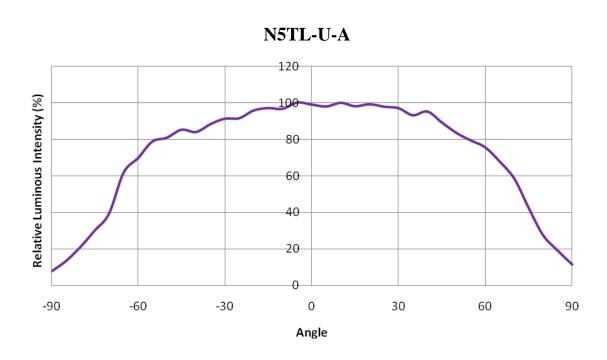
Relative Spectral Power Distribution, Ta=25 °C

UV



Typical Spatial Radiation Pattern

UV

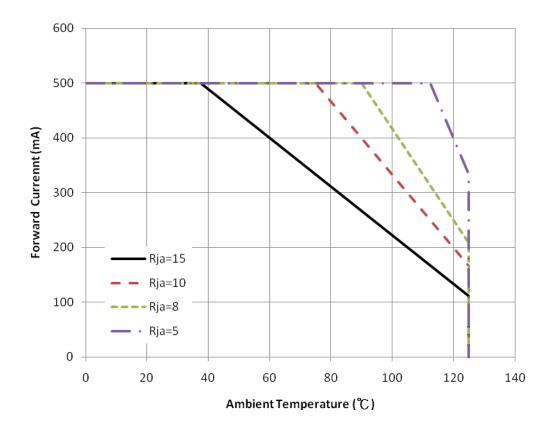






Thermal Design

Thermal design of the end product is important. The thermal resistance between the junction and the solder point $(R\Theta_{J-s})$ and the end product should be designed to minimize the thermal resistance from the solder point to ambient in order to optimize the emitter life and optical characteristics. The maximum operation current is determined by the plot of Allowable Forward Current vs. Ambient Temperature.



The junction temperature can be correlated to the thermal resistance between the junction and ambient (Rja) by the following equation.

Tj: LED junction temperature

Ta: Ambient temperature

Rja: Thermal resistance between the junction and ambient

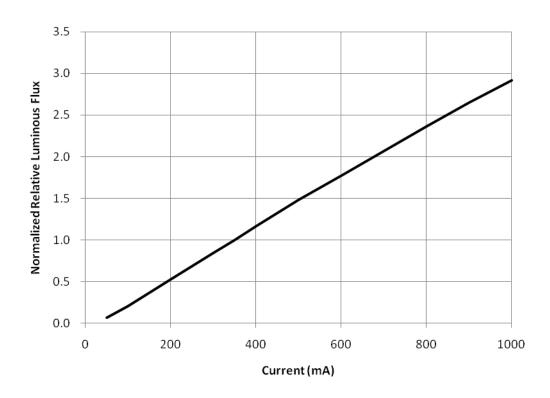
W: Input power (I_F*V_F)





Typical Forward L-I Characteristics

UV



Typical Forward I-V Characteristics

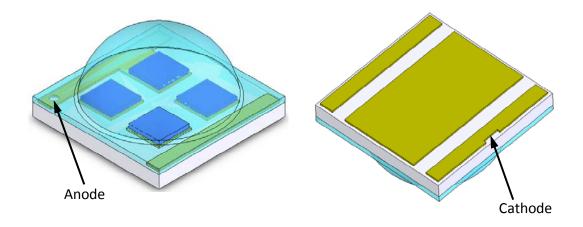
UV

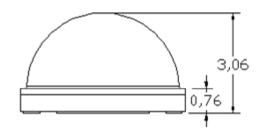




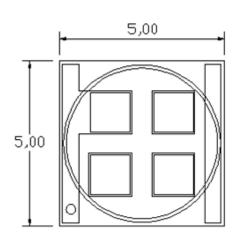


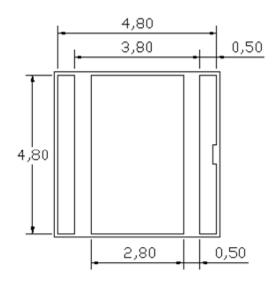
Mechanical Dimensions











Notes:

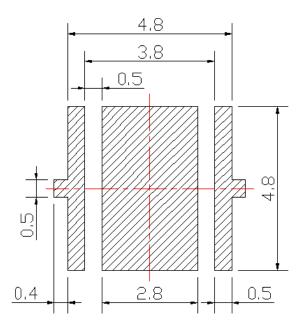
- 1. Drawing is not to scale
- 2. All dimensions are in millimeter
- 3. Dimensions are ± 0.13 mm unless otherwise indicated



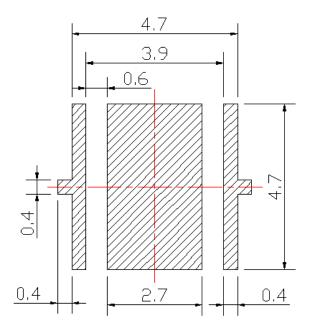


Recommended Solder Pad Design

Recommended Soldering Pad Design



Recommended Stencil Pattern Design (Mark Area is Opening)



Notes:

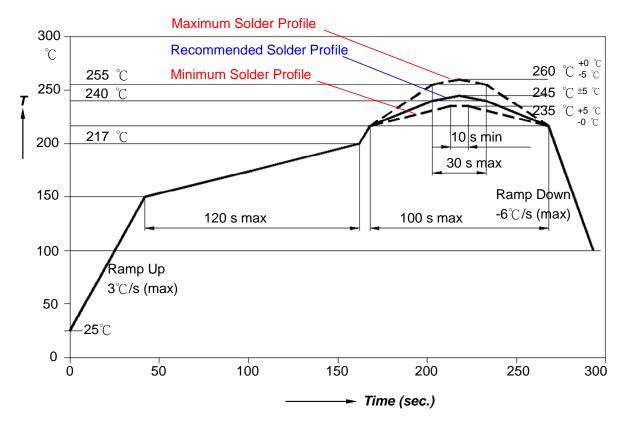
- 1. Drawing is not to scale
- 2. All dimensions are in millimeter





Recommended Soldering Profile

The LEDs can be soldered using the parameter listed below. As a general guideline, the users are suggested to follow the recommended soldering profile provided by the manufacturer of the solder paste. Although the recommended soldering conditions are specified in the list, reflow soldering at the lowest possible temperature is preferred for the LEDs.



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Average Ramp-up Rate (Tsmax to Tp)	3°C/second max.	3℃/second max.	
Preheat			
 Temperature Min(Tsmin) 	100 ℃	150 ℃	
 Temperature Max(Tsmax) 	150 ℃	200 ℃	
 Time(tsmin to tsmax) 	60-120 seconds	60-180 seconds	
Time maintained above:			
 Temperature(TL) 	183°C	217 ℃	
- Time(tL)	60-150 seconds	60-150 seconds	
Peak/classification	215 ℃	260°C	
Temperature(Tp)			
Time within 5°C of actual Peak	10-30 seconds	20. 40 seconds	
Temperature(tp)	10-30 seconds	20-40 seconds	
Ramp-Down Rate	6°C/second max.	6°C/second max.	
Time 25℃ to Peak Temperature	6 minutes max.	8 minutes max.	





About Us

SemiLEDs Corporation is a US based manufacturer of ultra-high brightness LED chips with state of the art fabrication facilities in Hsinchu Science Park, Taiwan. SemiLEDs specializes in the development and manufacturing of vertical LED chips in blue (white), green, and UV using a patented copper alloy base. This unique design allows for higher performance and longer lumen maintenance. In December 2008, The World Economic Forum recognized SemiLEDs innovations with the 2009 Technology Pioneer Award. SemiLEDs is fully ISO 9001:2008 Certified

SemiLEDs is a publicly traded company on NASDAQ Global Select Market (stock symbol "LEDS"). For investor information, please contact us at investors@semileds.com.

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